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(54) **Organic light emitting diode display**

Anzeige mit organischen Leuchtdioden

Dispositif d'affichage à diodes organique luminescentes

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Description

1. Field of the Invention

5 **[0001]** Aspects of the present disclosure relate to an organic light emitting diode (OLED) display. More particularly, aspects of the present disclosure relate to an OLED display having enhanced mechanical strength, due to an improved bezel that supports a panel assembly.

2. Description of the Related Art

10 **[0002]** An OLED display includes a plurality of OLEDs, each having a hole injection electrode, an organic emissive layer, and an electron injection electrode. The OLEDs emit light using energy generated when excitons, generated by electron-hole combinations in the organic light emitting layer, drop from an excitation state to a ground state.

15 **[0003]** By the above principle, OLED displays have a self-emissive characteristic. Therefore, unlike liquid crystal displays (LCDs), OLED displays do not require a separate light source, and thus, the thickness and weight thereof can be reduced. Further, OLED displays have low power consumption, high luminance, quick response, and the like. Therefore, OLED displays are drawing attention as the preferred displays for portable electronic devices.

20 **[0004]** Generally, a typical OLED display includes a panel assembly in which OLEDs are formed, a bezel coupled to the panel assembly, at a rear side of the panel assembly, and a printed circuit board (PCB) electrically connected to the panel assembly, by a flexible printed circuit board (FPCB). A panel assembly of an LCD includes two thin substrates, and liquid crystal filled in a space between these substrates. Unlike an LCD, an OLED display is designed such that empty spaces exist inside of the panel assembly. Therefore, the mechanical strength of an OLED may be compromised.

25 **[0005]** Therefore, when a user accidentally drops an electronic device having an OLED display, relatively large torsion loads and/or relatively large bending loads are applied to the bezel, and thus, the bezel is deformed. As a result, the torsion loads and/or the bending loads are transferred to the panel assembly, which is coupled to the bezel. This may cause damage to the panel assembly.

[0006] The above information is disclosed for enhancement of understanding of the background of the invention, and therefore, it may contain information that does not constitute prior art.

30 **[0007]** TW 247 552 B discloses an organic light emitting diode display comprising a display panel assembly comprising a display region, a pad region, and a plurality of organic light emitting diodes formed in the display region, a bezel including a bottom plate and side walls, the side walls being arranged to frame the edges of the display panel assembly, and the bottom plate being arranged to counter the rear surface of the display panel assembly, the OLED display further comprising a fixing member which is arranged between and fixed to the rear surface of the display panel assembly and the front surface of the bottom plate of the bezel, the display panel assembly and the bezel being coupled to each other

35 and mutually spaced apart by the fixing member, wherein the fixing member is a double-sided adhesive tape.
[0008] US 2005/184662 A1 discloses an OLED display device comprising a display panel, a bezel-like backplate with side-walls facing the edges of the display panel and a bottom plate on which the display panel is fixed via an adhesive thermally conducting layer in a position so as to be laterally spaced apart from the bezel-like backplate. The lateral gap between the display panel and the bezel-like backplate is also filled with said adhesive thermally conductive layer. The bezel-like backplate serves as a heat sink.

40 **[0009]** WO2008/057143 discloses an OLED display device comprising a display panel, a bezel with side-walls facing the edges the display panel and a bottom member on which the display panel is fixed via a shock absorbing bonding layer in a position so as to be laterally spaced apart from the bezel. The lateral gap between the display panel and the bezel is filled with another adhesive shock absorbing filler.

45 **[0010]** US 2008/007159 A1 discloses an OLED display wherein the driver IC is located on the rear side of a container receiving the OLED panel.

[0011] EP-A-1 655 128 discloses an adhesive impact-absorbing sheet which comprises an impact absorber including a single layer or a laminate of a rubber foam (e.g. urethane) and an adhesive layer on at least one surface of the impact absorber.

50 **[0012]** US-A-6 055 029 discloses a frame like bezel member for a backlight light guide of an LCD device having grooves (slits) or holes therein in order to compensate deformations under thermal variations.

SUMMARY OF THE INVENTION

55 **[0013]** The present invention provides an OLED display having enhanced mechanical strength and impact resistance, due to an improved bezel, which is coupled to a panel assembly.

[0014] According to the present invention, an organic light emitting diode (OLED) display includes the features of appended claim 1.

[0015] In an exemplary embodiment of the present invention, the bezel may include a pair of long side portions, between which an opening is defined, and a pair of short side portions, between which the opening is also defined, one of the short side portions, which corresponds to the pad region, being provided with a recess portion. The OLED display may further include: a flexible printed circuit board fixed on the pad region, and bent toward the rear surface of the fixing member, and enclosing the recess portion; and a printed circuit board electrically connected to the flexible printed circuit board.

[0016] In an exemplary embodiment of the present invention, the OLED display may include an impact absorption member located between the display panel assembly and the fixing member. The impact absorption member may include an impact absorption layer formed of a sponge material or of urethane, and an adhesive layer formed on a surface of the impact absorption layer, facing the display panel assembly.

[0017] In an exemplary embodiment of the present invention, the front surface of the bezel may be in the same plane as, or disposed in front of the front surface of the panel assembly. The width of the bezel may be greater than the thickness of the bezel. According to the present invention, the bezel is spaced apart from an outer perimeter of the display panel assembly.

[0018] In an exemplary embodiment of the present invention, the OLED display may include a filler located between the display panel assembly and the bezel. The bezel may be formed of one of stainless steel, cold drawn steel, aluminum, an aluminum alloy, a magnesium alloy, and a nickel alloy.

[0019] The bezel may extend around four edges of the display panel assembly.

[0020] Additional aspects and/or advantages of the invention will be set forth in part in the description which follows and, in part, will be obvious from the description, or may be learned by practice of the invention.

BRIEF DESCRIPTION OF THE DRAWINGS

[0021] These and/or other aspects and advantages of the invention will become apparent, and more readily appreciated, from the following description of the exemplary embodiments, taken in conjunction with the accompanying drawings, of which:

FIG. 1 is an exploded perspective view of an OLED display, according to a first exemplary embodiment of the present invention;

FIG. 2 is an assembled perspective view of the OLED display of FIG. 1;

FIG. 3 is a cross-sectional view taken along line I-I of FIG. 2;

FIG. 4 is a circuit diagram of a sub-pixel circuit of a panel assembly depicted in FIG. 1;

FIG. 5 is an enlarged cross-sectional view of a portion of the panel assembly depicted in FIG. 1;

FIG. 6 is an exploded perspective of an OLED display of a comparative example;

FIG. 7 is an assembled perspective view of the OLED display of FIG. 6;

FIG. 8 is a schematic diagram of a drop jig used for a drop test;

FIG. 9 is a cross-sectional view of an OLED display, according to a second exemplary embodiment of the present invention;

FIG. 10 is an OLED display, not according to the present invention;

FIG. 11 is a perspective view of a bezel of the OLED display of FIG. 10;

FIG. 12 is a perspective view of a modified example of the bezel of FIG. 11;

FIG. 13 is a perspective view of another modified example of the bezel of FIG. 11; and

FIG. 14 is a perspective view of still another modified example of the bezel of FIG. 11.

DETAILED DESCRIPTION OF THE EXEMPLARY EMBODIMENTS

[0022] Reference will now be made in detail to the exemplary embodiments of the present invention, examples of which are illustrated in the accompanying drawings, wherein like reference numerals refer to the like elements throughout. The exemplary embodiments are described, below in order to explain the aspects of the present invention, by referring to the figures.

[0023] FIG. 1 is an exploded perspective view of an OLED display 100, according to a first exemplary embodiment of the present disclosure, FIG. 2 is an assembled perspective view of the OLED display 100, and FIG. 3 is a cross-sectional view taken along line I-I, of FIG. 2. Referring to FIGS. 1 to 3, the OLED display 100 includes: a panel assembly 20 having a display region A10 to display an image, and a pad region A20; a bezel 410 coupled to the panel assembly 20; and a printed circuit board (PCB) 36 electrically connected to the panel assembly 20, via a flexible printed circuit board (FPCB) 32.

[0024] The panel assembly 20 includes a first substrate 12 and a second substrate 14. The second substrate 14 is smaller than the first substrate 12, and has a peripheral portion coupled to the first substrate 12, by a sealant. The display

region A10 is defined at an overlapping region of the first and second substrates 12 and 14. The display region A10 is surrounded by the sealant. The pad region A20 is disposed outside of the sealant.

[0025] A plurality of sub-pixels are disposed in a matrix pattern, in the display region A10 of the first substrate 12. Scan and data drivers (not shown) to drive the sub-pixels, are located between the display region A10 and the sealant, or outside of the sealant. Pad electrodes (not shown) transfer electric signals to the scan and data drivers, and are located in the pad region A20.

[0026] FIG. 4 is a circuit diagram of a sub-pixel circuit of the panel assembly 20, and FIG. 5 is an enlarged cross-sectional view of a portion of the panel assembly 20. Referring to FIGS. 4 and FIG. 5, each of the sub-pixels of the panel assembly 20 includes an OLED L1 and a driving circuit unit. The OLED L1 includes an anode electrode 16, an organic emissive layer 18, and a cathode electrode 22. The driving circuit unit includes at least two thin film transistors and at least one storage capacitor C1. The thin film transistors include at least one switching transistor T1 and at least one driving transistor T2.

[0027] The switching transistor T1 is connected to scan and data lines SL1 and DL1, to transfer a data voltage, which is an input from the data line DL1, in accordance with a switching voltage input to the scan line SL1, to the driving transistor T2. The storage capacitor C1 is connected to a power line VDD, as well as to the switching transistor T1, to store a voltage corresponding to a difference between a voltage transferred from the switching transistor T1, and a voltage supplied from the power line VDD.

[0028] The driving transistor T2 is connected to both the power line VDD and the storage capacity C1, to supply an output current I_{OLED} to the OLED L1, which corresponds to a square of the difference between a voltage stored in the storage capacity C1, and a threshold voltage. The OLED L1 can emit light using the output current I_{OLED} . The driving transistor T2 includes a source electrode 24, a drain electrode 26, and a gate electrode 28. The anode electrode 16 is connected to the drain electrode 26. The above-described structure of the sub-pixels is exemplary only, and may be modified in various ways.

[0029] The second substrate 14 is coupled to the first substrate 12 by the sealant, at a predetermined interval, to protect the driving circuit unit and the OLEDs on the first substrate 12 from an external environment. A polarizing plate (not shown) to suppress reflections of external light, may be located on an outer surface of the second substrate 14, at the display region A10. A moisture absorption agent (not shown) may be attached on an inner surface of the second substrate 14.

[0030] Referring again to FIGS. 1 to 3, an integrated circuit chip 30 is mounted at the pad region A20 of the panel assembly 20, through a chip-on-glass (COG) method. The FPCB 32 is also mounted at the pad region A20, through a chip-on-film (COF) method. A protective layer 34 is formed around the integrated circuit chip 30 and the FPCB 32, to cover and protect pad electrodes formed at the pad region A20.

[0031] A variety of electronic elements (not shown) for processing driving signals are mounted on the PCB 36. A connector 38, to transfer external signals to the PCB 36, is also installed on the printed circuit board 36. In the present exemplary embodiment, the bezel 410 has a frame structure framing the edges of the panel assembly and not the bottom surface of the panel assembly. The bezel 410 includes a pair of long side portions 44, between which an opening 42 is defined, and a pair of short side portions 46, between which the opening 42 is also defined. The panel assembly 20 is fitted in the opening 42, such that the bezel 410 is located around the perimeter of the panel assembly 20. That is, the bezel 410 is not provided with a bottom portion, on which the panel assembly 20 is disposed. Therefore, the perimeter of the panel assembly 20 is facing the inner surface of the bezel 410.

[0032] A fixing member 50, to fix the bezel 410 and the panel assembly 20, is disposed on rear surfaces of the panel assembly 20 and bezel 410. The fixing member 50 may be a single-sided adhesive tape, having a base layer 501 and an adhesive layer 502 formed on a surface of the base layer 501, which faces the panel assembly 20 and the bezel 410 (see FIG. 1). Therefore, the panel assembly 20 is fixed to a central portion of the fixing member 50, and the bezel 410 is fixed on a peripheral portion of the fixing member 50. As a result, the panel assembly 20 and the bezel 410 are coupled to each other, by the fixing member 50, while at the same time the bezel 410 and panel assembly are provided spaced apart.

[0033] The FPCB 32, which is fixed at the pad region A20, is folded toward a rear surface of the fixing member 50, at one of the short side portions 46 of the bezel 410. One of the short side portions 46 is provided with a recess portion 48, through which the FPCB 32 passes. Thus, the respective short portion 46 has a stepped profile with thicker or higher portions where the FPCB 32 does not pass relative to portions where the FPCB 32 is arranged. That is, a front surface of the recess portion 48 is lower than a front surface of the short side portions 46. Therefore, the FPCB 32 is bent toward the rear surface of the fixing member 50, while enclosing the short side portion 46 that includes the recess portion 48.

[0034] An impact absorption member 52 may be located between the panel assembly 20 and the fixing member 50, to absorb external impacts. The impact absorption member 52 includes an impact absorption layer 521 and an adhesive layer 522 formed on a surface of the impact absorption layer 521, which faces the panel assembly 20 (see FIG. 3). The impact absorption layer 521 may be flexible and may be formed of a sponge material or urethane. The impact absorption member 52 attenuates external impacts applied to the panel assembly 20, to protect the panel assembly 20.

5 [0035] The front surface of the bezel 410 may be located in the same plane as the front surface of the panel assembly 20, or may be located in front of the front surface of the panel assembly 20. As referred to herein, the front surface of the OLED display 100, and the various components thereof, relates to the surface upon which an image is displayed. That is, if the impact absorption member 52 is not provided, a thickness of the bezel 410 may be equal to, or greater than, that of the panel assembly 20. When the impact absorption member 52 is provided, the thickness of the bezel 410 may be equal to, or greater than, the sum of the thicknesses of the panel assembly 20 and the impact absorption member 52.

10 [0036] FIG. 3 shows an exemplary embodiment where a thickness T of the bezel 410 is the same as the sum of the thicknesses of the panel assembly 20 and the impact absorption member 52. If the front surface of the bezel 410 is lower than the front surface of the panel assembly 20, an impact load, which is generated when an external impact is applied to the OLED display 100, is directly transferred to the panel assembly 20. This may damage the panel assembly 20.

15 [0037] The outer perimeter (side surfaces) of the panel assembly 20 are spaced apart from the inner wall (inner perimeter) of the bezel 410, by a gap G (see FIG. 3). Therefore, even when the bezel 410 is deformed by an external impact, the deformation of the bezel 410 does not directly affect the panel assembly 20. In order to enable the impact absorption member 52 to contact the bezel 410, the impact absorption member 52 may be formed to have a larger surface area than the panel assembly 20 (see FIG. 3).

20 [0038] In order to have a proper strength, the bezel 410 is designed to have a width W that is greater than the thickness (or height) T (see FIG. 3). The width W may be at least 40% greater than the thickness T or may be at least twice as large as the thickness T. If the width W of the bezel 410 is less than the thickness T, the bezel 410 may not have a sufficient resistance to bending.

25 [0039] When it is assumed that an overall thickness of the panel assembly 20, including a polarizing plate (not shown), is 0.56mm, and the impact absorption member 52 is omitted, the bezel 410 is designed to have a width W of about 1.05mm, and a thickness T of about 0.74mm. However, the width W and thickness T of the bezel 410 are not so limited, and may vary in accordance with the size and thickness of the panel assembly 20.

30 [0040] The bezel 410 may be formed of a high strength metal, such as stainless steel, cold drawn steel, aluminum, an aluminum alloy, a magnesium alloy, a nickel alloy, and the like. The aluminum alloy and the magnesium alloy are lightweight materials, and they can be used to reduce an overall weight of the OLED display 100.

35 [0041] As the bezel 410 is formed in a frame shape, and has a thickness greater than the panel assembly 20, the strength of the bezel 410 can be enhanced, and thus, the deformations of the bezel 410 can be reduced. Further, since the inner perimeter of the bezel 410 is spaced apart from the outer perimeter of the panel assembly 20, by the gap G, the deformation of the bezel 410 does not directly affect the panel assembly 20, and thus, the panel assembly 20 can be further protected.

40 [0042] 12 Comparative Examples, each including a conventional bezel and an associated panel assembly having a display region whose diagonal length is 55.88mm (2.2 inches), were prepared. FIGS. 6 and 7 show a conventional OLED display 200, which is used as a comparative example. The OLED display 200 includes a bezel 510 having a bottom portion 54 on which a panel assembly 20 is disposed, and sidewalls 56 extending from side edges of the bottom portion 54, except for a side edge at which an FPCB 32 is bent toward the panel assembly 20. A double-sided adhesive tape 58 is located between the bottom portion 54 of the bezel 510 and the panel assembly 20, to fix the panel assembly 20 on the bezel 510.

45 [0043] In FIGS. 1, 6, and 7, like reference numbers refer to like parts, except for the bezels. In the comparative OLED display 200, the thickness of the panel assembly 20 is 0.41 mm, the thickness of the bottom portion 54 of the bezel 510 is 0.15, the thickness of the double-sided adhesive tape 58 is 0.03, and the thickness of a polarizing plate (not shown), attached on an outer surface of the second substrate 14, is 0.15mm. Therefore, an overall thickness of the comparative OLED display 200 is 0.74mm.

50 [0044] Referring again to FIGS. 1-3, 5 test samples of Example 1, each of which was made by associating the bezel 410 without the impact absorption member 52, with the panel assembly 20 having the display region A10, whose diagonal length is 55.88mm (2.2 inches), were prepared. In addition, 10 test samples of Example 2, each of which is made by varying a width of the bezel of the OLED display of Example 1, were also prepared. Further, 10 test samples of Example 3, each of which was made by associating the bezel 410 having the impact absorption member 52, with the panel assembly 20 having the display region A10, whose diagonal length is 55.88mm (2.2 inches), were also prepared.

55 [0045] With regard to Examples 1, 2, and 3, the thickness of the panel assembly 20, the thickness of the polarizing plate disposed on the outer surface of the second substrate 14, the thickness of the impact absorption member 52, and the width W and thickness T of the bezel 410, are shown in the following table 1.

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[Table 1]

	Thickness of Panel Assembly (mm)	Thickness of Polarizing plate	Thickness of Impact Absorption Member (mm)	Thickness of Bezel (mm)	Width of Bezel (mm)
Example 1	0.41	0.15	0	0.74	1.05
Example 2	0.41	0.15	0	0.74	2
Example 3	0.41	0.15	0.15	0.74	1.7

[0046] A drop test, for determining damage to the panel assembly 20, was performed by allowing a drop jig, with each of the test samples attached thereto, to execute a free-fall from a height of 1.8m.

[0047] FIG. 8 is a schematic diagram of a drop jig 60 used for the drop test. The drop jig 60 includes an upper case 62 and a lower case 64. An OLED display is mounted in a space defined by the upper and lower cases 62 and 64. The drop jig 60 was dropped in the first through sixth directions, as indicated by the arrows. The drop test was performed 18 times (3 times for each of the six directions) for each test sample.

[0048] Drop impact resistance points of each test sample, total drop impact resistance points, and average of the drop impact resistance points, of the Comparative Example and Examples 1 to 3, are shown in the following table 2. In the 18 drop tests, the drop impact resistance points were calculated, by giving 1 point when the panel assembly 20 is not damaged, and by giving 0 points when the panel assembly 20 is damaged.

[Table 2]

		Drop Impact Resistance Point			
		Comparative Example	Example 1	Example 2	Example 3
Test Samples	1	6	6	13	18
	2	1	0	18	18
	3	1	12	18	18
	4	1	13	18	18
	5	7	18	18	18
	6	13	-	1	18
	7	13	-	6	18
	8	7	-	16	18
	9	1	-	1	-
	10	1	-	18	-
	11	12	-	-	-
	12	1	-	-	-
Total		64	49	127	160
Average		5.3	9.8	12.7	16

[0049] As shown in Table 1, the OLED displays of Examples 1 to 3 have more drop impact resistance points than the OLED displays 200 of the Comparative Example. That is, in the OLED displays 200 of the Comparative Example, the bottom portion 54 of the bezel 510 was easily deformed by the external impacts, and the deformation of the bottom portion 54 directly affected the panel assembly 20. As a result, the panel assembly 20 was easily damaged. On the other hand, in the OLED displays 100 of Examples 1 to 3, since the bottom portion was omitted from the bezel, and the strength of the bezel was enhanced, the damage of the panel assembly was suppressed, as shown in Table 2.

[0050] Particularly, it can be noted that the OLED display of Example 3, having the impact absorption member 52, had more drop impact resistance points than the OLED displays of Examples 1 and 2. That is, the OLED display of Example 3 had a higher mechanical strength than the OLED displays of Examples 1 and 2.

[0051] FIG. 9 is a cross-sectional view of an OLED display 101, according to a second exemplary embodiment of the

present invention. Referring to FIG. 9, the OLED display 101 is similar to the OLED display 100, except that a filler 66 is located between a panel assembly 20 and a bezel 410. In the first and second exemplary embodiments, like reference numbers are used to refer to like parts.

[0052] The filler 66 is formed of a material having high impact-resistance and flexibility. For example, the filler 66 may be formed of an epoxy resin. The filler 66 increases the fixing force applied to the panel assembly 20, and attenuates impacts transferred from the bezel 410 to the panel assembly 20, thereby protecting the panel assembly 20.

[0053] FIG. 10 is an OLED display 102, not according to the present invention, and FIG. 11 is a perspective view of a bezel 420 depicted in FIG. 10. Referring to FIGS. 10 and 11, the OLED display 102 includes a panel assembly 20, the bezel 420, and a fixing member 503 disposed between the panel assembly 20 and the bezel 420. The fixing member 503 may be formed of an epoxy resin having a high viscosity, a high flexibility, and a high impact-resistance. One short side portion of the bezel 420, which corresponds to a pad region A20, is omitted. That is, the bezel 420 includes a pair of long side portions 44' and one short side portion 46'.

[0054] The bezel 420 is formed to have a high flexibility. For example, the bezel 420 may be formed of a synthetic resin, rather than a metal. The bezel 420 has a plurality of grooves 68 on top and bottom surfaces thereof, to reduce the thickness/weight of the bezel 420 at various locations.

[0055] The OLED display 102 is similar to the OLED display 100, except a fixing member 503 and a bezel 420 are modified. Like reference numbers are used to refer to like parts.

[0056] Generally, panel assemblies are manufactured by simultaneously forming a plurality of panel assemblies on a mother substrate, and cutting the mother substrate in units corresponding to the panel assemblies. At this point, fine cracks may be formed on side surfaces of the panel assembly 20, as a cutting wheel passes through the mother substrate. External impacts are generally transferred to the panel assembly 20, through the side surfaces of the panel assembly 20. Therefore, damage to the panel assembly 20 begins at the side surfaces.

[0057] In the OLED display 102, the bezel 420 is located around parts of the outer perimeter of the panel assembly 20, the mechanical strength of the side surfaces (the outer perimeter) of the panel assembly 20 is enhanced, and the resistance to bending force is increased, thereby effectively protecting the panel assembly 20 from external impacts. The panel assembly 20 can be protected from damage that can occur during mounting of the OLED display 102 on an electronic device, or when conveying the OLED display 102. Thus, the quality of products incorporating the OLED display 102 can be improved.

[0058] FIG. 12 is a perspective view of a modified example of the bezel of Fig. 11. The bezel 430 of Fig. 12 is similar to the bezel 420 of Fig. 11, except that a plurality of grooves 70 are formed on inner and outer side surfaces of a bezel 430, to partly reduce a width/weight of the bezel 430.

[0059] FIG. 13 is a perspective view of another modified example of the bezel of Fig. 11. The bezel 440 of Fig. 13 is similar to the bezel 420 of Fig. 11, except that a plurality of holes 72 are formed on inner and outer side surfaces of a bezel 440.

[0060] FIG. 14 is a perspective view of another modified example of the bezel of Fig. 11. The bezel 450 of Fig. 14 is similar to the bezel 420 of Fig. 11, except that a plurality of holes 74 are formed in front and rear surfaces of a bezel 450.

Claims

1. An organic light emitting diode display (100), OLED display, comprising:

a display panel assembly (20) comprising a display region (A10), a pad region (A20), and a plurality of organic light emitting diodes formed in the display region (A10);

a frame-like bezel (410) provided such that it frames the edges of the display panel assembly (20) and not the rear surface of the display panel assembly (20); and

a fixing member (50) fixed to the rear surface of the display panel assembly (20) and to the rear surface of the bezel (410), the display panel assembly (20) and the bezel (410) being coupled to each other and mutually spaced apart by the fixing member (50), wherein

the fixing member (50) is a single-side adhesive tape, which comprises a base layer (501) and an adhesive layer (502) formed on a surface of the base layer (501), the adhesive layer (502) facing the display panel assembly (20) and the bezel (410).

2. The OLED display (100) of claim 1, wherein the bezel (410) has a pair of long side portions (44), and a pair of short side portions (46), the long and short side portions (44, 46) defining an opening (42), and one of the short side portions (46), which corresponds to the pad region (A20), has a recess portion (48).

3. The OLED display (100) of claim 2, further comprising:

a flexible printed circuit board (32) fixed on the pad region (A20), and bent toward the rear surface of the fixing member (50), around the recess portion (48); and
 a printed circuit board (36) electrically connected to the flexible printed circuit board (32).

- 5 4. The OLED display (100) of any of the previous claims, further comprising an impact absorption member (52) disposed between the display panel assembly (20) and the fixing member (50).
- 10 5. The OLED display (100) of claim 4, wherein the impact absorption member (52) comprises an impact absorption layer (521) and an adhesive layer (522) formed on a surface of the impact absorption layer (521), which faces the display panel assembly (20),
 wherein the impact absorption layer (521) is formed of a sponge material or a urethane material.
- 15 6. The OLED display (100) of any of the previous claims, wherein the front surface of the bezel (410) is in the same plane as, or is disposed in front of, the front surface of the display panel assembly (20).
7. The OLED display (100) of any of the previous claims, wherein the width (W) of the bezel (410) is greater than the thickness (T) of the bezel (410).
- 20 8. The OLED display (100) of claim 4, wherein the impact absorption member (52) extends into a space between the bezel (410) and the display panel assembly (20).
9. The OLED display (100) of any of the previous claims, further comprising a filler (66) located between the display panel assembly (20) and the bezel (410).
- 25 10. The OLED display (100) of any of the previous claims, wherein the bezel (410) is formed of one of stainless steel, cold drawn steel, aluminum, an aluminum alloy, a magnesium alloy, and a nickel alloy.
- 30 11. The OLED display (100) of any of the previous claims, wherein the bezel (410) is disposed around four edges of the display panel assembly (20).

Patentansprüche

- 35 1. Anzeige mit organischen Leuchtdioden (100), OLED-Display, umfassend:
 eine Anzeigetafelanordnung (20) umfassend einen Anzeigebereich (A10), einen Kontaktbereich (A20) und eine Vielzahl von im Anzeigebereich (A10) ausgebildeten organischen Leuchtdioden;
 eine rahmenähnliche Einfassung (410), die derart angeordnet ist, dass sie die Kanten der Anzeigetafelanordnung (20) und nicht die Rückfläche der Anzeigetafelanordnung (20) einrahmt; und
 40 ein Befestigungselement (50), das an der Rückfläche der Anzeigetafelanordnung (20) und an der Rückfläche der Einfassung (410) befestigt ist, wobei die Anzeigetafelanordnung (20) und die Einfassung (410) miteinander verbunden und durch das Befestigungselement (50) voneinander beabstandet sind, wobei
 das Befestigungselement (50) ein einseitiges Klebeband ist, das eine Basisschicht (501) und eine Klebeschicht (502) aufweist, die auf einer Fläche der Basisschicht (501) gebildet ist, wobei die Klebeschicht (502) der Anzeigetafelanordnung (20) und der Einfassung (410) zugewandt ist.
- 45 2. OLED-Display (100) nach Anspruch 1, wobei die Einfassung (410) ein Paar langer Seitenbereiche (44) und ein Paar kurzer Seitenbereiche (46) aufweist, wobei die langen und kurzen Seitenbereiche (44, 46) eine Öffnung (42) definieren und einer der kurzen Seitenbereiche (46), der dem Kontaktbereich (A20) entspricht, einen ausgesparten Bereich (48) aufweist.
- 50 3. OLED-Display (100) nach Anspruch 2, weiterhin umfassend:
 eine flexible Leiterplatte (32), die an dem Kontaktbereich (A20) befestigt und um den ausgesparten Bereich (48) herum zur Rückfläche des Befestigungselements (50) gebogen ist; und
 eine mit der flexiblen Leiterplatte (32) elektrisch verbundene Leiterplatte (36).
- 55 4. OLED-Display (100) nach einem der vorangegangenen Ansprüche, weiterhin umfassend ein Stoßdämpfungsele-

ment (52), das zwischen derAnzeigetafelanordnung (20) und dem Befestigungselement (50) angeordnet ist.

- 5 5. OLED-Display (100) nach Anspruch 4, wobei das Stoßdämpfungselement (52) eine stoßdämpfende Schicht (521) und eine auf einer Oberfläche der stoßdämpfenden Schicht (521) ausgebildete Klebeschicht (522), die der Anzeigetafelanordnung (20) zugewandt ist, umfasst, wobei die stoßdämpfende Schicht (521) aus einem Schwammmaterial oder einem Urethanmaterial besteht.
- 10 6. OLED-Display (100) nach einem der vorangegangenen Ansprüche, wobei die Vorderfläche der Einfassung (410) in derselben Ebene wie die oder vor der Vorderfläche der Anzeigetafelanordnung (20) liegt bzw. angeordnet ist.
7. OLED-Display (100) nach einem der vorangegangenen Ansprüche, wobei die Breite (W) der Einfassung (410) größer ist als die Dicke (T) der Einfassung (410).
- 15 8. OLED-Display (100) nach Anspruch 4, wobei sich das Stoßdämpfungselement (52) bis in einen Zwischenraum zwischen der Einfassung (410) und der Anzeigetafelanordnung (20) erstreckt.
9. OLED-Display (100) nach einem der vorangegangenen Ansprüche, weiterhin umfassend einen Füllstoff (66), der sich zwischen der Anzeigetafelanordnung (20) und der Einfassung (410) befindet.
- 20 10. OLED-Display (100) nach einem der vorangegangenen Ansprüche, wobei die Einfassung (410) aus Edelstahl, Blankstahl, Aluminium, einer Aluminiumlegierung, einer Magnesiumlegierung oder einer Nickellegierung besteht.
- 25 11. OLED-Display (100) nach einem der vorangegangenen Ansprüche, wobei die Einfassung (410) um vier Kanten der Anzeigetafelanordnung (20) herum angeordnet ist.

Revendications

- 30 1. Dispositif d'affichage (100) à diodes électroluminescentes organiques, dispositif d'affichage à OLED, comprenant :
 - un ensemble de panneau d'affichage (20) comprenant une région d'affichage (A10), une région de plage d'accueil (A20), et une pluralité de diodes électroluminescentes organiques formées dans la région d'affichage (A10) ;
 - 35 une lunette d'encadrement (410) en forme de cadre prévue de sorte à encadrer les bords de l'ensemble de panneau d'affichage (20) et non la surface arrière de l'ensemble de panneau d'affichage (20) ; et
 - un élément de fixation (50) fixé à la surface arrière de l'ensemble de panneau d'affichage (20) et à la surface arrière de la lunette d'encadrement (410), l'ensemble de panneau d'affichage (20) et la lunette d'encadrement (410) étant couplés entre eux et
 - 40 espacés l'un de l'autre par l'élément de fixation (50), dans lequel l'élément de fixation (50) est une bande adhésive à une seule face, qui comprend une couche de base (501) et une couche adhésive (502) formée sur une surface de la couche de base (501), la couche adhésive (502) se trouvant en vis-à-vis de l'ensemble de panneau d'affichage (20) et de la lunette d'encadrement (410).
- 45 2. Dispositif d'affichage à OLED (100), de la revendication 1, dans lequel la lunette d'encadrement (410) a une paire de parties latérales longues (44), et une paire de parties latérales courtes (46), les parties latérales longues et courtes (44, 46) définissant une ouverture (42), et l'une des parties latérales courtes (46), qui correspond à la région de plage d'accueil (A20), comporte une partie en évidement (48).
- 50 3. Dispositif d'affichage à OLED (100) de la revendication 2, comprenant en outre :
 - une carte de circuit imprimé souple (32) fixée sur la région de plage d'accueil (A20), et fléchie vers la surface arrière de l'élément de fixation (50), autour de la partie en évidement (48) ; et
 - une carte de circuit imprimé (36) connectée électriquement à la carte de circuit imprimé souple (32).
- 55 4. Dispositif d'affichage à OLED (100) de l'une quelconque des revendications précédentes, comprenant en outre un élément d'absorption d'impacts (52) disposé entre l'ensemble de panneau d'affichage (20) et l'élément de fixation (50).

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5. Dispositif d'affichage à OLED (100) de la revendication 4, dans lequel l'élément d'absorption d'impacts (52) comprend une couche d'absorption d'impacts (521) et une couche adhésive (522) formée sur une surface de la couche d'absorption d'impacts (521), qui est en vis-à-vis de l'ensemble de panneau d'affichage (20), dans lequel la couche d'absorption d'impacts (521) est réalisée en un matériau éponge ou un matériau uréthane.
 6. Dispositif d'affichage à OLED (100) de l'une quelconque des revendications précédentes, dans lequel la surface frontale de la lunette d'encadrement (410) se trouve dans le même plan que, ou est disposée devant la surface frontale de l'ensemble de panneau d'affichage (20).
 7. Dispositif d'affichage à OLED (100) de l'une quelconque des revendications précédentes, dans lequel la largeur (W) de la lunette d'encadrement (410) est supérieure à l'épaisseur (T) de la lunette d'encadrement (410).
 8. Dispositif d'affichage à OLED (100) de la revendication 4, dans lequel l'élément d'absorption d'impacts (52) s'étend dans un espace entre la lunette d'encadrement (410) et l'ensemble de panneau d'affichage (20).
 9. Dispositif d'affichage à OLED (100) de l'une quelconque des revendications précédentes, comprenant en outre un bourrage (66) situé entre l'ensemble de panneau d'affichage (20) et la lunette d'encadrement (410).
 10. Dispositif d'affichage à OLED (100) de l'une quelconque des revendications précédentes, dans lequel la lunette d'encadrement (410) est formée en l'un parmi de l'acier inoxydable, de l'acier étiré à froid, de l'aluminium, et un alliage d'aluminium, un alliage de magnésium et un alliage de nickel.
 11. Dispositif d'affichage à OLED (100) de l'une quelconque des revendications précédentes, dans lequel la lunette d'encadrement (410) est disposée autour de quatre bords de l'ensemble de panneau d'affichage (20).

FIG. 1

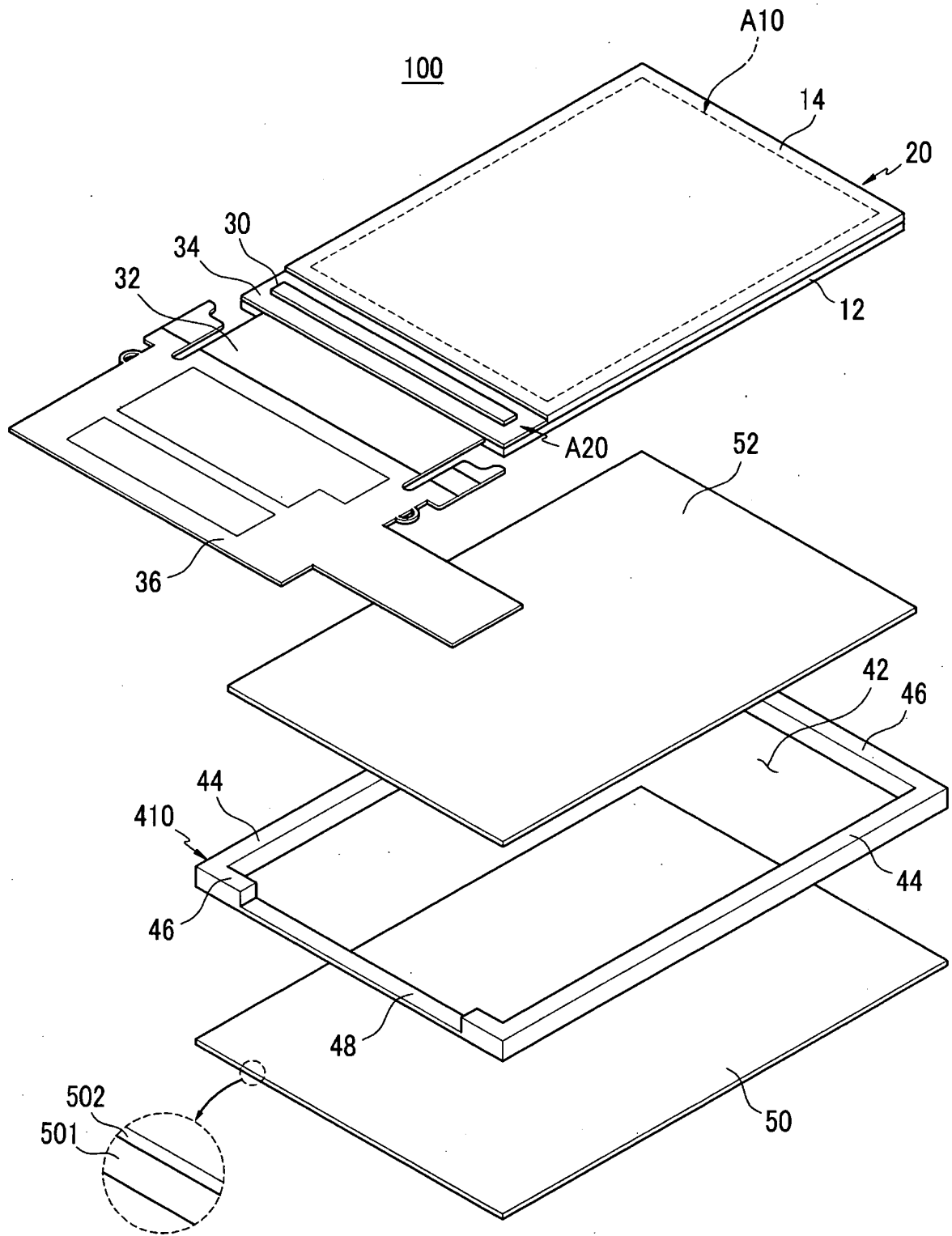


FIG.2

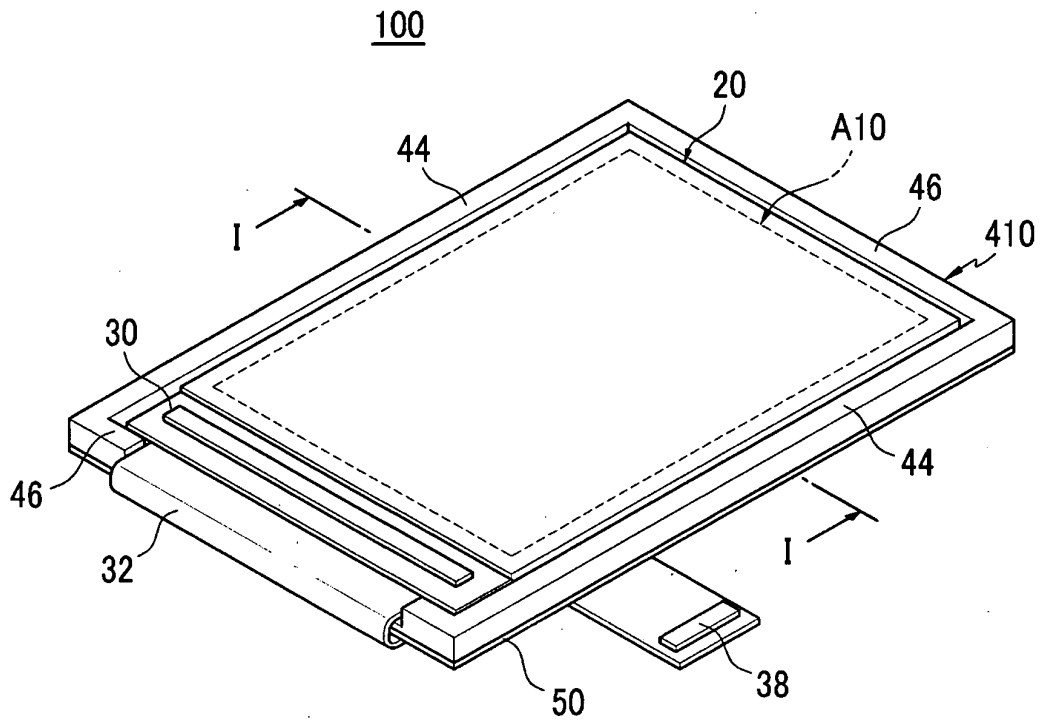


FIG.3

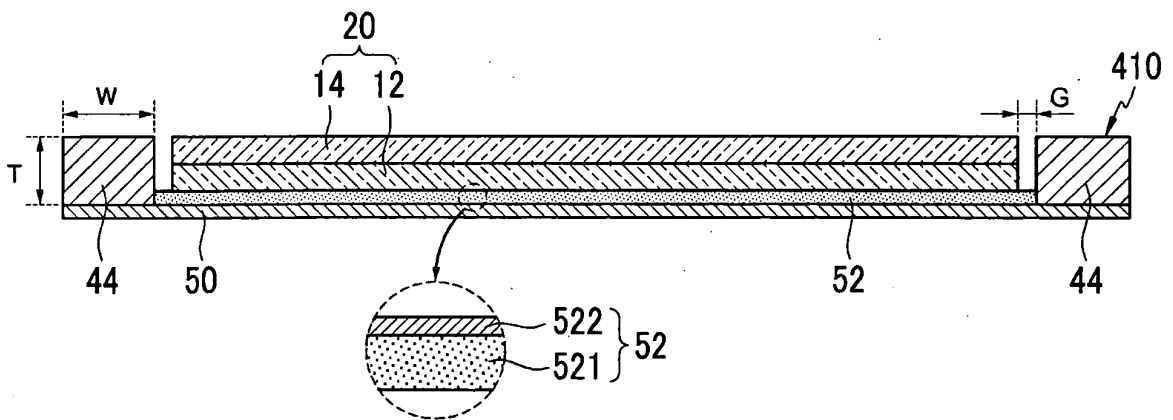


FIG.4

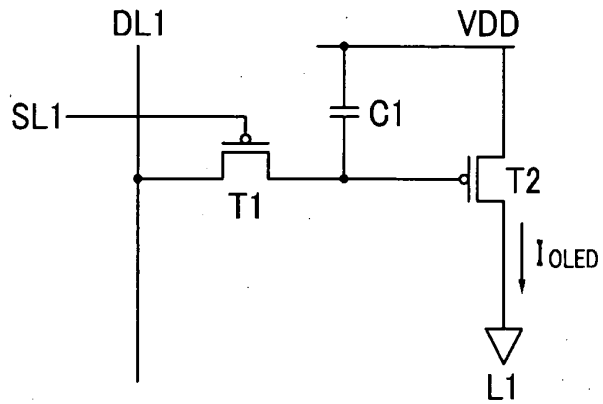


FIG.5

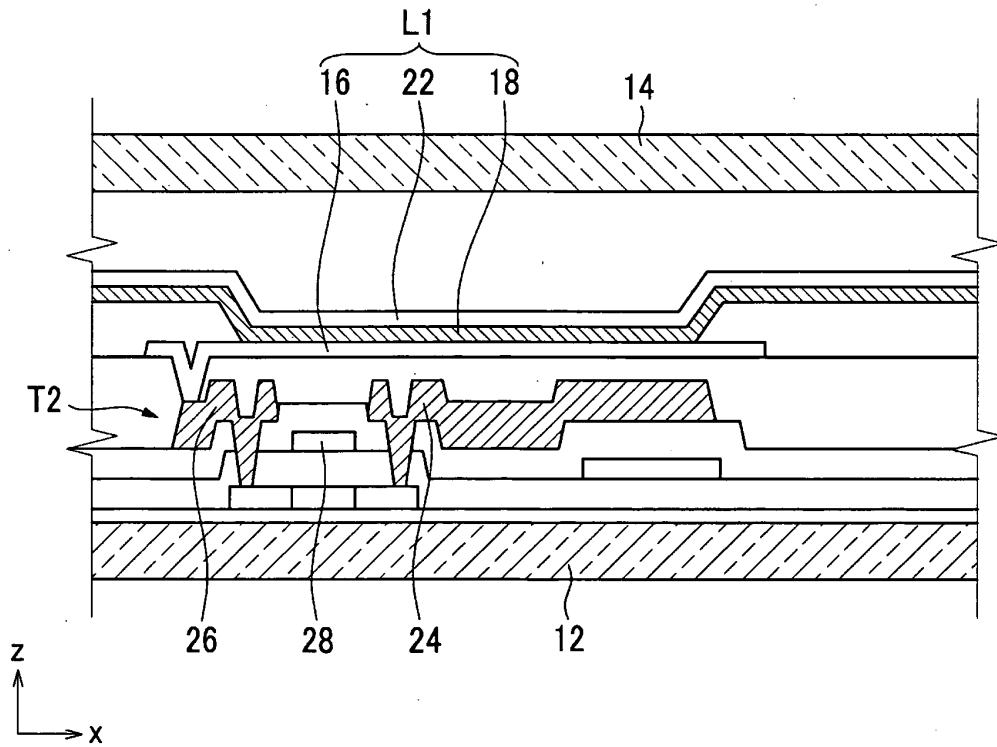


FIG.6
(RELATED ART)

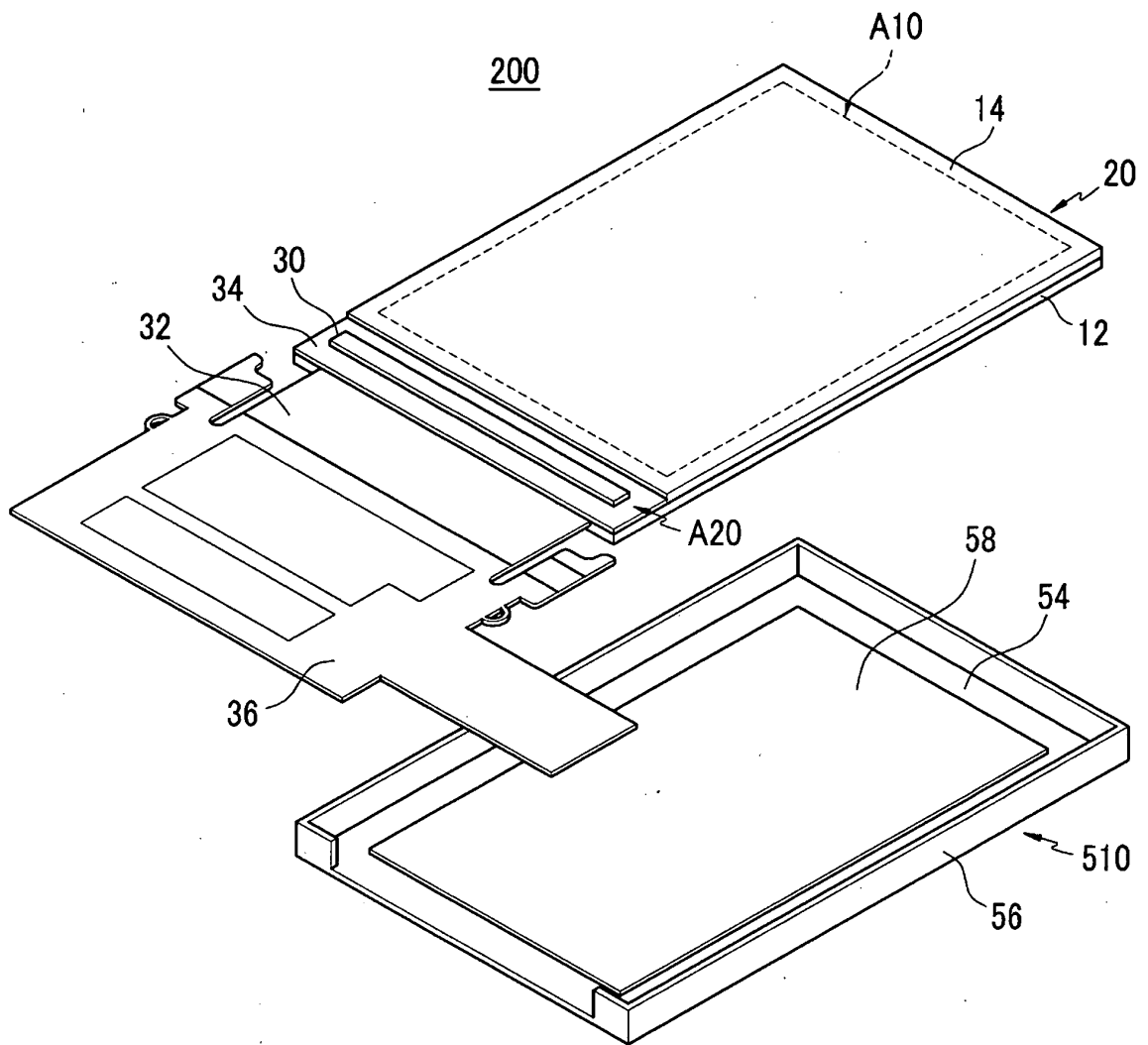


FIG.7
(RELATED ART)

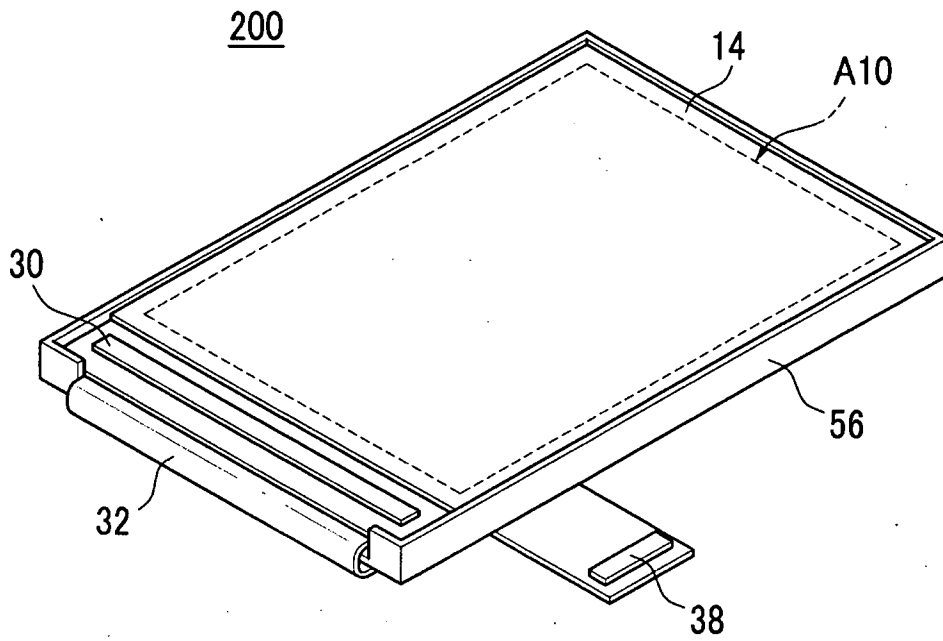


FIG.8

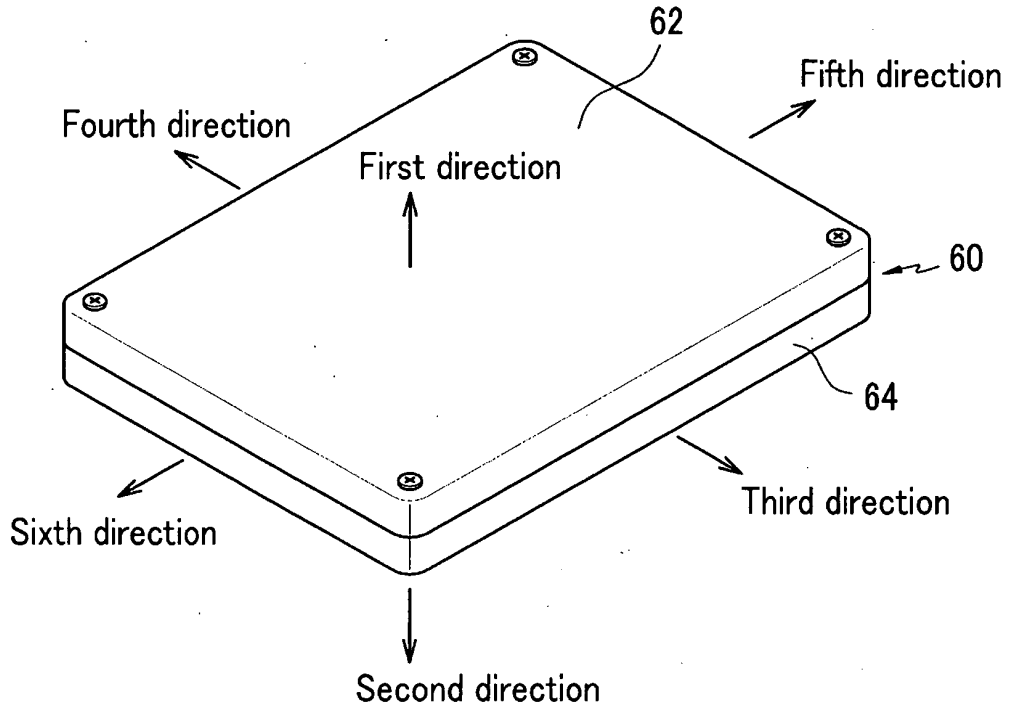


FIG.9

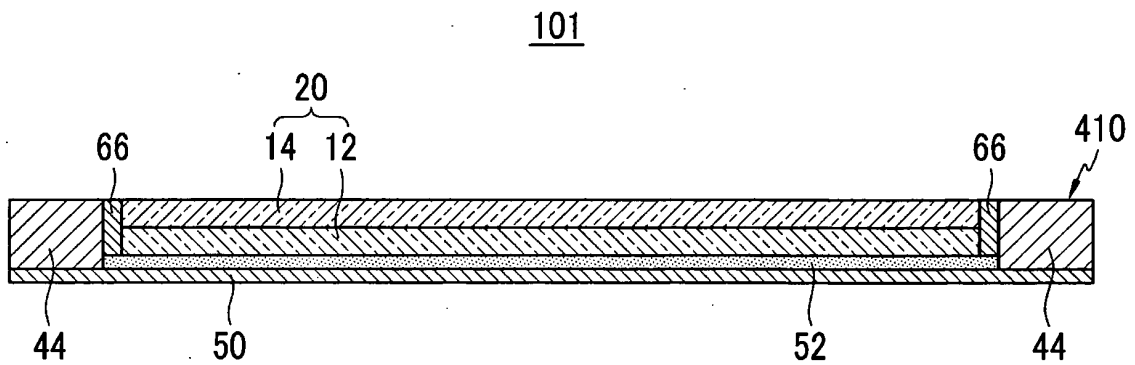


FIG.10

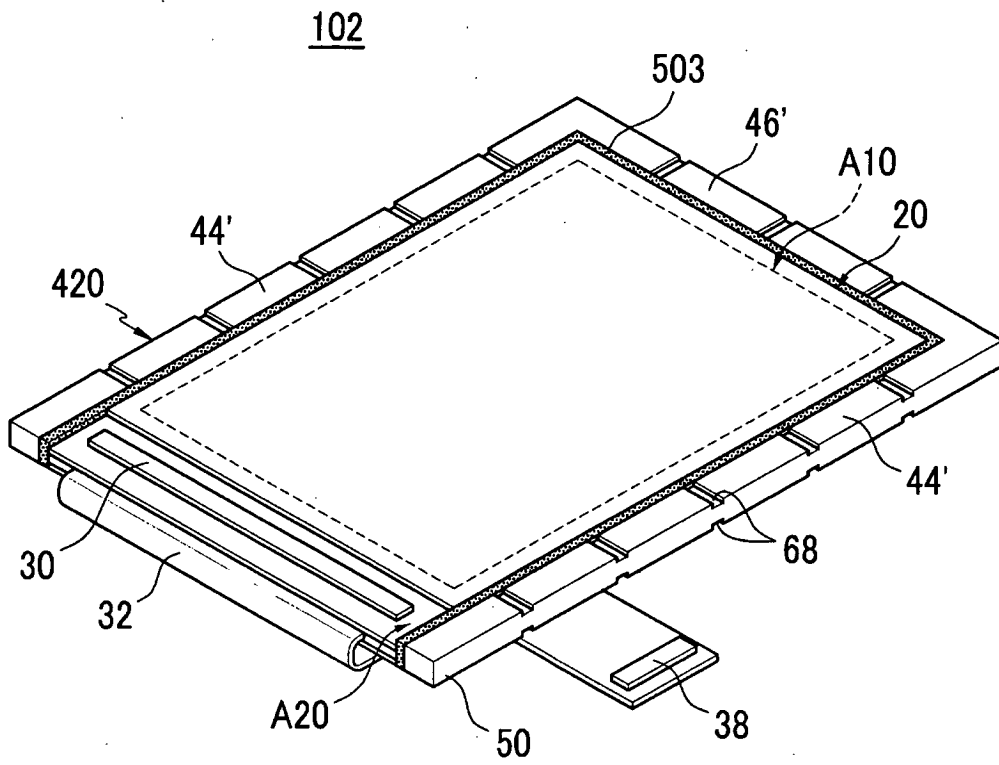


FIG.11

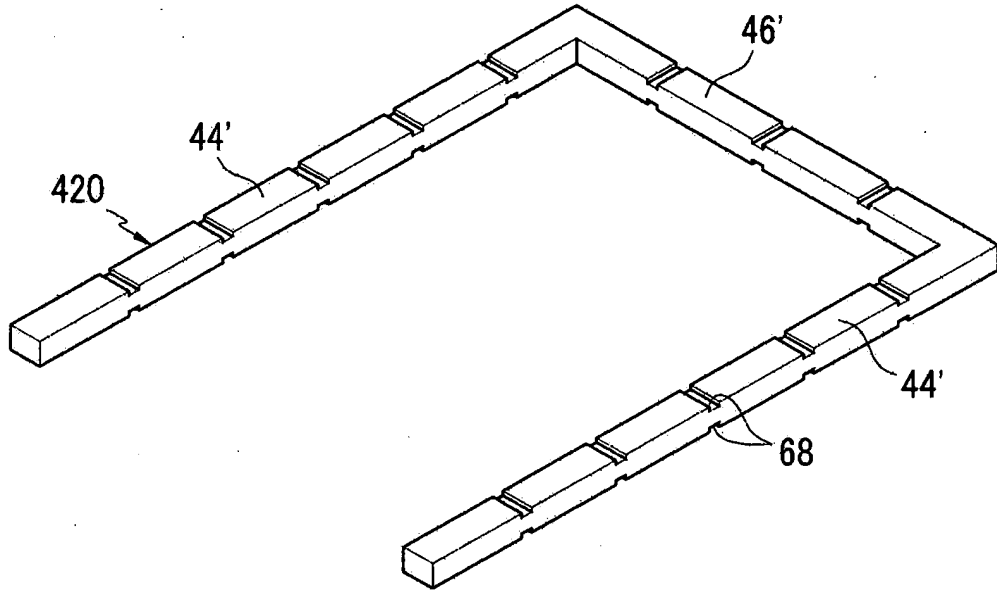


FIG.12

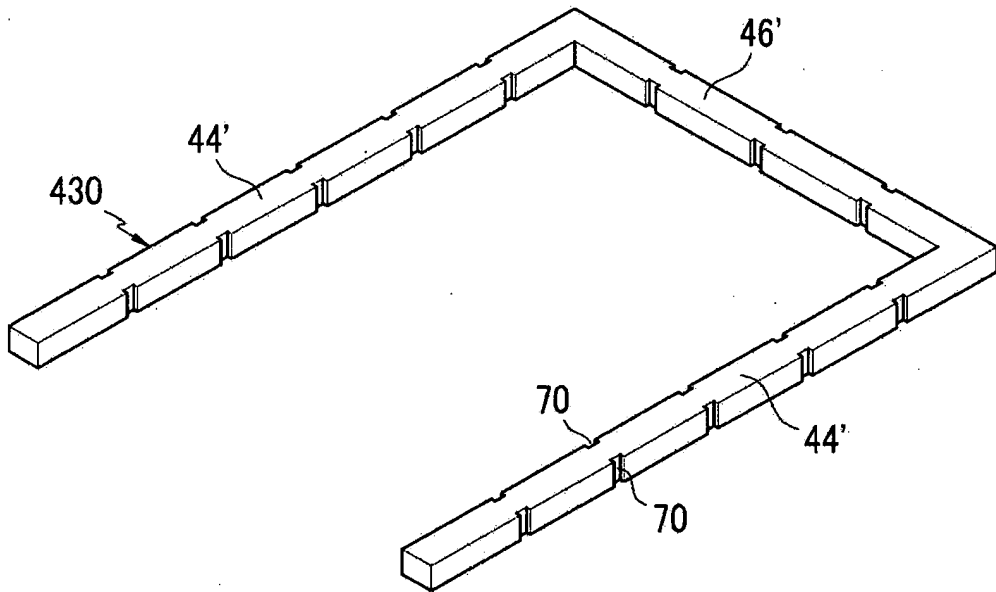


FIG.13

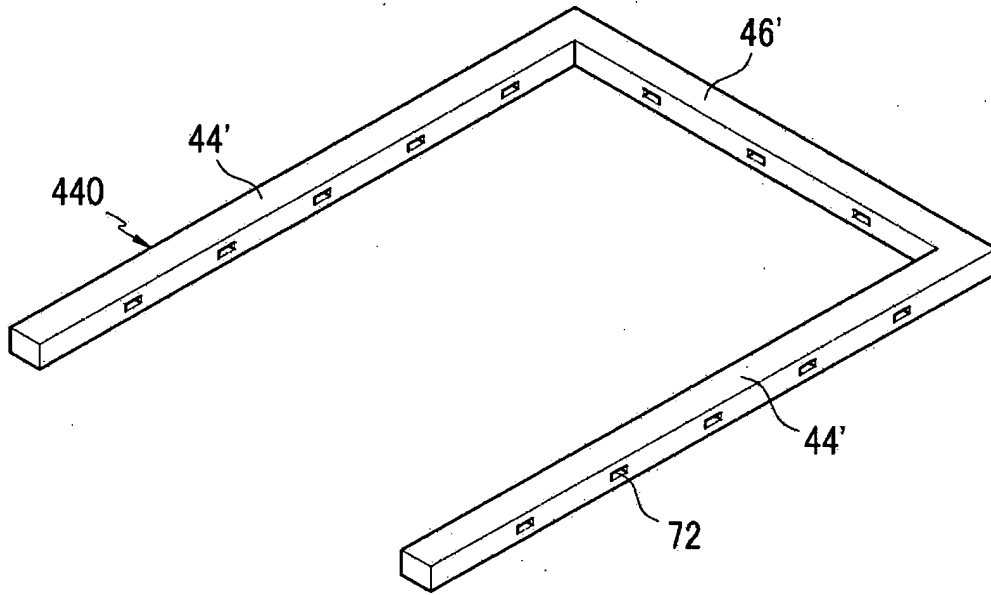
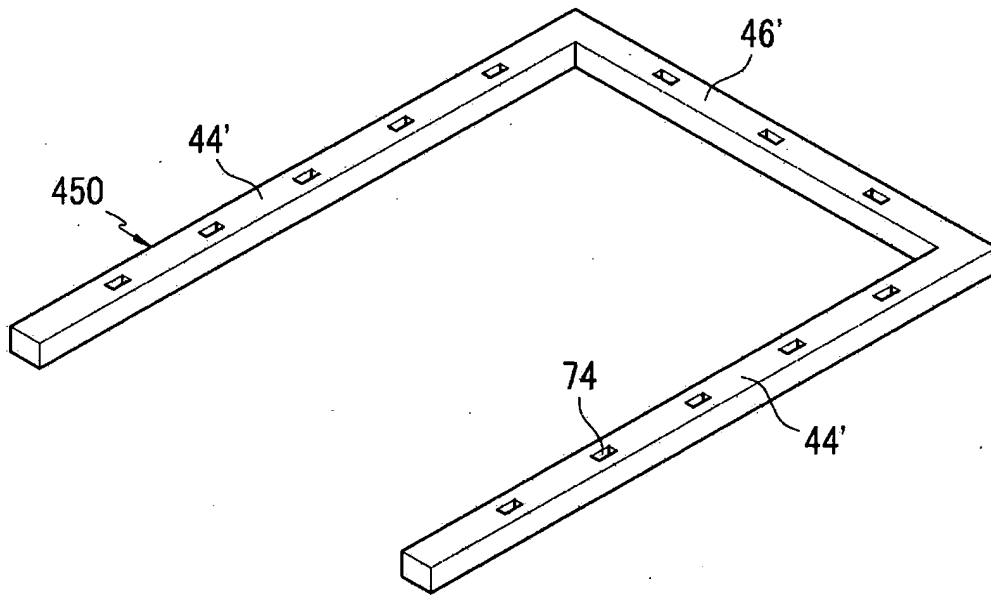


FIG.14



REFERENCES CITED IN THE DESCRIPTION

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其他公开文献	EP2086008A1		
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摘要(译)

一种OLED显示器 (100) , 包括 : 面板组件 (20) , 具有显示区域 (A10) , 焊盘区域 (A20) , 以及形成在显示区域 (A10) 中的多个 OLED; 边框 (410) 设置在面板组件 (20) 周围并与面板组件 (20) 间隔开; 固定构件 (50) , 用于将面板组件 (20) 固定到边框 (410) 上。

